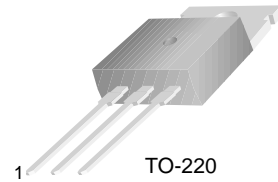


High Voltage Switching Dynamic Focus Application

- High Collector-Emitter Breakdown Voltage : $BV_{CEO}=900V$
- Small $C_{ob} \approx 2.8pF$ (Typ.)
- Wide S.O.A
- High reliability



TO-220
1.Base 2.Collector 3.Emitter

NPN Triple Diffused Planar Silicon Transistor

Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	1500	V
V_{CEO}	Collector-Emitter Voltage	900	V
V_{EBO}	Emitter-Base Voltage	5	V
I_C	Collector Current (DC)	100	mA
I_{CP}	Collector Current (Pulse)	300	mA
P_C	Collector Dissipation ($T_C=25^\circ C$)	10	W
T_J	Junction Temperature	150	$^\circ C$
T_{STG}	Storage Temperature	- 55 ~ 150	$^\circ C$

Electrical Characteristics $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C=1mA, I_E=0$	1500			V
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C=5mA, I_B=0$	900			V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E=1mA, I_C=0$	5			V
I_{CBO}	Collector Cut-off Current	$V_{CB}=900V, I_E=0$			10	μA
I_{EBO}	Emitter Cut-off Current	$V_{EB}=4V, I_C=0$			10	μA
h_{FE}	*DC Current Gain	$V_{CE}=5V, I_C=10mA$	30			
$V_{CE(sat)}$	*Collector-Emitter Saturation Voltage	$I_C=20mA, I_B=4mA$			5	V
$V_{BE(sat)}$	*Base-Emitter Saturation Voltage	$I_C=20mA, I_B=4mA$			2	V
C_{ob}	Output Capacitance	$V_{CB}=100V, f=1MHz$		2.8		pF

* Pulse test: $PW = 300\mu s$, Duty Cycle = 2% pulsed

Typical Characteristics

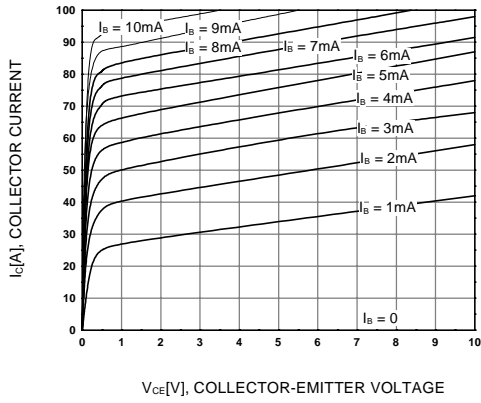


Figure 1. Static Characteristic

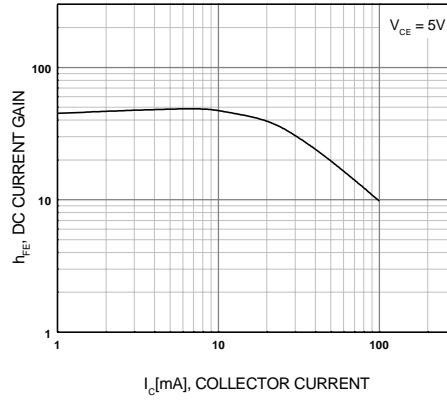


Figure 2. DC current Gain

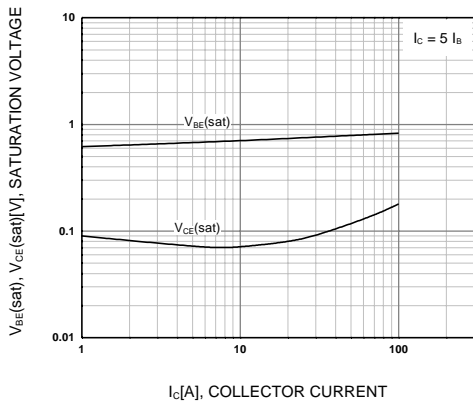


Figure 3. Base-Emitter Saturation Voltage
Collector-Emitter Saturation Voltage

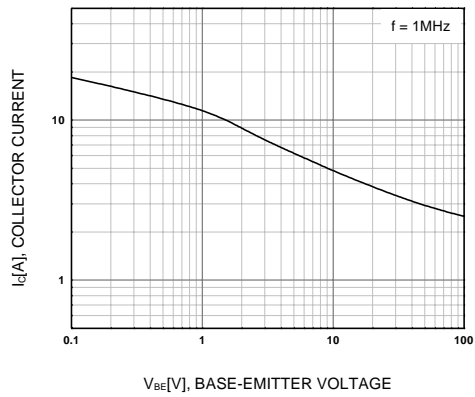


Figure 4. Collector Output Capacitance

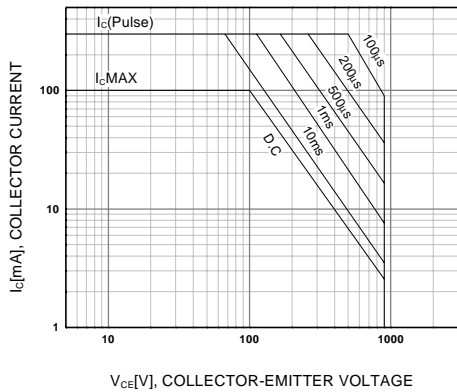


Figure 5. Safe Operating Area

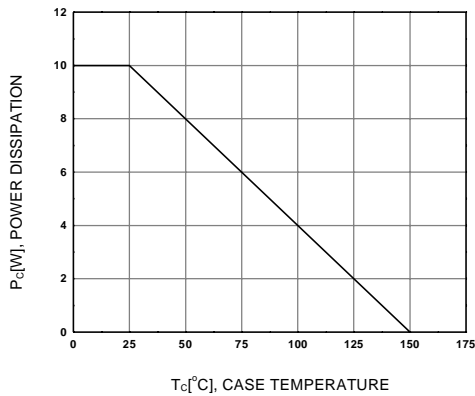
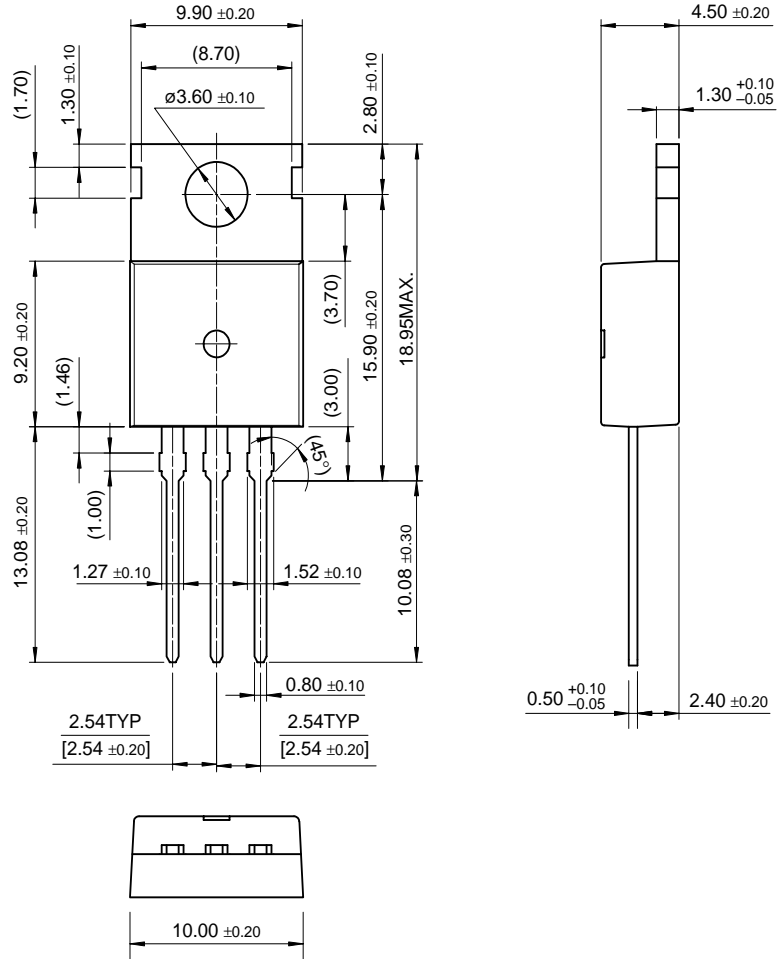


Figure 6. Power Derating

Package Dimensions

TO-220



Dimensions in Millimeters

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